

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT2655075

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>HYUNSOO YANG</td> <td>11/20/2013</td> </tr> <tr> <td>SANKHA SUBHRA MUKHERJEE</td> <td>11/25/2013</td> </tr> <tr> <td>JAE HYUN KWON</td> <td>11/25/2013</td> </tr> </tbody> </table>		Name	Execution Date	HYUNSOO YANG	11/20/2013	SANKHA SUBHRA MUKHERJEE	11/25/2013	JAE HYUN KWON	11/25/2013		
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<table border="1"> <tr> <td>Name:</td> <td>NATIONAL UNIVERSITY OF SINGAPORE</td> </tr> <tr> <td>Street Address:</td> <td>21 LOWER KENT RIDGE ROAD</td> </tr> <tr> <td>City:</td> <td>SINGAPORE</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>119077</td> </tr> </table>		Name:	NATIONAL UNIVERSITY OF SINGAPORE	Street Address:	21 LOWER KENT RIDGE ROAD	City:	SINGAPORE	State/Country:	SINGAPORE	Postal Code:	119077
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CORRESPONDENCE DATA											
Fax Number:	(703)683-8396										
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ATTORNEY DOCKET NUMBER:	32850U										
NAME OF SUBMITTER:	JERALD L. MEYER										
Signature:	/Jerald L. Meyer/										

Date:	12/19/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 3 source=ExecutedDecAssignment_32850U_1#page1.tif source=ExecutedDecAssignment_32850U_2#page1.tif source=ExecutedDecAssignment_32850U_3#page1.tif	

DECLARATION UNDER 37 CFR §1.63 AND ASSIGNMENT

As the undersigned inventor, I hereby declare that this Declaration under 37 CFR §1.63 is directed to the following invention:

Title: **Spinwave Based Nondestructive Material, Structure, Component, or Device**

U.S. application serial number or PCT international application number

14/020,329

Filed on **September 6, 2013**

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, **National University of Singapore**

whose business address is **21 Lower Kent Ridge Road, Singapore, 119077 Singapore.**

hereinafter referred to as the ASSIGNEE, desires to acquire the entire right, title and interest for the United States and elsewhere throughout the world in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof.

NOW, THEREFORE, in consideration of the sum of one dollar (\$1.00) and other good and valuable consideration, the receipt, adequacy and sufficiency of which are hereby acknowledged, the undersigned hereby assigns, sells and transfers to said ASSIGNEE, its assigns and legal representatives, the entire right, title and interest for the United States and elsewhere throughout the world, in and to said invention and application, including any and all divisions and continuations thereof, all rights of priority under the terms of the International Convention for the Protection of Industrial Property, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges, and advantages in any way arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives, in as ample and as beneficial a manner for all intents and purposes as the undersigned might or could have held and enjoyed the same had this assignment not been made.

The undersigned hereby agrees to execute all papers necessary to file said applications in the United States and elsewhere throughout the world, and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing any and all Letters Patent thereon. The undersigned authorizes and requests the Commissioner of Patents to issue a Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

I hereby acknowledge that any willful false statement made in this Declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF INVENTOR: **Hyunsoo YANG**

INVENTOR SIGNATURE: 

DATE: 20 Nov 2013

DECLARATION UNDER 37 CFR §1.63 AND ASSIGNMENT

As the undersigned inventor, I hereby declare that this Declaration under 37 CFR §1.63 is directed to the following invention:

Title: **Spinwave Based Nondestructive Material, Structure, Component, or Device Testing**

U.S. application serial number or PCT international application number

14/020,329

Filed on **September 6, 2013**

The above-identified application was made or authorized to be made by me.

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LEGAL NAME OF INVENTOR: **Sankha Subhra MUKHERJEE**

INVENTOR SIGNATURE: *Sankha S. Mukherjee*

DATE: Monday, November 25th 2013

DECLARATION UNDER 37 CFR §1.63 AND ASSIGNMENT

As the undersigned inventor, I hereby declare that this Declaration under 37 CFR §1.63 is directed to the following invention:

Title: **Spinwave Based Nondestructive Material, Structure, Component, or Device Testing Tools**

U.S. application serial number or PCT international application number

14/020,329

Filed on **September 6, 2013**

The above-identified application was made or authorized to be made by me.

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LEGAL NAME OF INVENTOR: **Jae Hyun KWON**

INVENTOR SIGNATURE: _____

DATE: 25 Nov. 2013